	12		DB	Time stamp
1	Hits	Search Text		
u_mber	!) li furmo\\ with	USPAT;	2002/11/14
1	242	(leadframe frame (lead ad) Irame) with	US-PGPUB;	03:03
		(EPO; JPO;	
	ļ		DERWENT;	
		1		
			IBM_TDB	2002/11/14
3	116549		USPAT;	02:58
	116549		US-PGPUB;	02:50
			EPO; JPO;	
	ļ		DERWENT;	
			IBM TDB	
		/ distantantan die	USPAT;	2002/11/14
	380647	"4" same (semiconductor chip die (integrated adj circuit))	US-PGPUB;	03:04
			EPO; JPO;	1
			DERWENT;	
			IBM TDB	
			USPAT;	2002/11/14
5	0	pad same (ring same ((leadframe frame	T	02:59
		(lead adj frame)) with (tiebar dambar)))	US-PGPUB;	02.33
		(Icaa aa) == ···· /·	EPO; JPO;	
			DERWENT;	1
	1		IBM_TDB	1
2 6 7	20	ring same ((leadframe frame (lead adj frame)) with (tiebar dambar))	USPAT;	2002/11/14
			US-PGPUB;	02:59
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
		+ h	USPAT;	2002/11/14
	41959	(leadframe frame (lead adj frame)) with ring	US-PGPUB;	03:04
			EPO; JPO;	00.0.
			DERWENT;	
			IBM_TDB	0000/11/14
		((leadframe frame (lead adj frame)) with	USPAT;	2002/11/14
	836		US-PGPUB;	03:04
		ring) same pad	EPO; JPO;	
	1		DERWENT;	
	1		IBM TDB	
	1			2002/11/14
	199	ring) same pad) same (semiconductor chip	US-PGPUB;	03:04
			05 10102,	03.01
		die (integrated adj circuit))	EPO; JPO;	
		410 (2	DERWENT;	
			IBM_TDB	